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**AEHR TEST SYSTEMS MOURNS LOSS OF  
VIVIAN POSEDEL, CO-FOUNDER AND FORMER CHIEF FINANCIAL OFFICER**

**Fremont, CA (April 9, 2009) - Aehr Test Systems (Nasdaq: AEHR)** announced today with great sadness that Vivian Posedel, a co-founder and former Chief Financial Officer of the Company, has passed away following a three-year battle with cancer. Mrs. Posedel, the wife of current Chairman and CEO Rhea Posedel, was a certified public accountant and a former auditor at a predecessor firm to PricewaterhouseCoopers.

“We are deeply saddened by the loss of a wonderful woman who was so valuable to the Company for many years,” said Mario Rosati, a director of Aehr Test Systems. “Our deepest sympathies go out to Rhea and the entire Posedel family.”

In lieu of flowers, the Posedel family has requested that donations be made to the Pine Street Foundation or other charitable organizations dedicated to cancer research and treatment. Pine Street Foundation can be contacted at [gifts@pinestreetfoundation.org](mailto:gifts@pinestreetfoundation.org) or (415) 455-5878.

**About Aehr Test Systems**

Headquartered in Fremont, California, Aehr Test Systems is a leading worldwide provider of systems for burning-in and testing DRAMs, flash, and other memory and logic integrated circuits and has an installed base of more than 2,500 systems worldwide. Aehr Test has developed and introduced several innovative products, including the ABTS, FOX™, MTX and MAX systems and the DiePak® carrier. The ABTS is Aehr Test’s newest system for packaged part test during burn-in for both low-power and high-power logic as well as all common types of memory devices. The FOX system is a full wafer contact test and burn-in system. The MTX system is a massively parallel test system designed to reduce the cost of memory testing by performing both test and burn-in on thousands of devices simultaneously. The MAX system can effectively burn-in and functionally test complex devices, such as digital signal processors, microprocessors, microcontrollers and systems-on-a-chip. The DiePak carrier is a reusable, temporary package that enables IC manufacturers to perform cost-effective final test and burn-in of bare die. For more information, please visit the Company’s website at [www.aehr.com](http://www.aehr.com).

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